AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions and listings of claims in the

application.

1. (currently amended)A method of fabricating a CMOS circuit comprising thick

oxide transistors and thin oxide transistors by a fabrication process, said method

comprising:

fabricating a differential logic circuit having a plurality of thin oxide transistors,

and having a plurality of logic inputs by the fabrication process; and

fabricating a current source, operable to supply bias current to the differential

logic circuit, comprising at least one thick oxide transistor by the fabrication process

and wherein the current source has a control input that can determine how much

current is available to source to the differential logic circuit and further comprising an

adaptive bias control coupled to at least one of the plurality of logic inputs that

provides a control signal at the control input of the current source to increase the

bias current available to the differential logic circuit; and

providing a control signal at the control input of the current source to increase

the bias current available to the differential logic circuit, said control signal being

responsive to a voltage transition on the at least one logic input.

2-11. (canceled)

12. (currently amended)A method of fabricating by a fabrication process a CMOS

circuit comprising thick oxide transistors and thin oxide transistors, said method

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comprising:

fabricating by the fabrication process a differential logic circuit comprising a

plurality of thin oxide transistors, and having a plurality of inputs;

fabricating by the fabrication process a current source, operable to supply

bias current to the differential logic circuit, the current source fabricated using at least

one thick oxide transistor, the current source having a control input that can

determine how much current is available to source to the differential logic circuit; and

fabricating by the fabrication process an adaptive bias control that provides a

control signal at the control input of the current source to selectively control the bias

current available to the differential logic circuit,

wherein the adaptive bias control is coupled to at least one of the plurality of

logic inputs and further comprising:

providing a control signal at the control input of the current source to increase

the bias current available to the differential logic circuit, said control signal being

responsive to a voltage transition on the at least one logic input.

13. (canceled)

14. (previously presented) The method according to claim 12, further

comprising a bias load circuit loading the differential logic circuit.

15-18. (canceled)

19. (currently amended) A method of fabricating a CMOS circuit using a process

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that can create thick oxide transistors and thin oxide transistors, comprising:

fabricating by the process a differential logic circuit comprising a plurality of

thin oxide transistors, and having a plurality of inputs, the differential logic circuit

further comprising a pair of matched thin oxide transistors configured as a differential

inverter;

fabricating by the process a current source, operable to supply bias current to

the differential logic circuit, the current source comprising a thick oxide transistor

receiving a supply voltage at a drain thereof and coupling a reduced supply voltage

to the differential logic circuit through a source thereof, the current source having a

control input at a gate thereof that can determine how much current is available to

source to the differential logic circuit; and

fabricating by the process an adaptive bias control that provides a control

signal at the control input of the current source to selectively control the bias current

available to the differential logic circuit,

wherein the adaptive bias control is coupled to at least one of the plurality of

logic inputs and further comprising:

providing a control signal at the control input of the current source to control

the bias current available to the differential logic circuit, said control signal being

responsive to a voltage transition on the at least one logic input.

20. (canceled)

21. (previously presented) The method according to claim 19, further

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comprising a bias load circuit loading the differential logic circuit.

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22-25. (canceled)

26. (previously presented) The method according to claim 1, wherein the

plurality of thin oxide transistors of the differential logic circuit fabricated by the

fabrication process are each characterized as having a higher switching speed and a

higher transconductance gm than the at least one thick oxide transistor of the current

source fabricated by the fabrication process.

27. (previously presented) The method according to claim 1, wherein the at

least one thick oxide transistor fabricated by the fabrication process is operable to

operate in a higher voltage condition than can the plurality of thin oxide transistors

fabricated by the fabrication process and is further characterized as being larger and

slower in operation than the plurality of thin oxide transistors.

28. (previously presented) The method according to claim 12, wherein the

plurality of thin oxide transistors of the differential logic circuit fabricated by the

fabrication process are each characterized as having a higher switching speed and a

higher transconductance gm than the at least one thick oxide transistor of the current

source fabricated by the fabrication process.

29. (previously presented) The method according to claim 12, wherein the at

least one thick oxide transistor fabricated by the fabrication process is operable to

operate in a higher voltage condition than can the plurality of thin oxide transistors

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fabricated by the fabrication process and is further characterized as being larger and slower in operation than the plurality of thin oxide transistors.

30. (previously presented) The method according to claim 19, wherein the plurality of thin oxide transistors of the differential logic circuit fabricated by the process are each characterized as having a higher switching speed and a higher transconductance gm than the at least one thick oxide transistor of the current source fabricated by the process.

31. (previously presented) The method according to claim 19, wherein the at least one thick oxide transistor fabricated by the process is operable to operate in a higher voltage condition than can the plurality of thin oxide transistors fabricated by the process and is further characterized as being larger and slower in operation than the plurality of thin oxide transistors.